

ATS688LSN

Two-Wire, Zero-Speed Differential Gear Tooth Sensor IC

Discontinued Product

This device is no longer in production. The device should not be purchased for new design applications. Samples are no longer available.

Recommended Substitutions: ATS19200

For existing customer transition, and for new customers or new applications, contact Allegro Sales.

NOTE: For detailed information on purchasing options, contact your local Allegro field applications engineer or sales representative.

Allegro MicroSystems reserves the right to make, from time to time, revisions to the anticipated product life cycle plan for a product to accommodate changes in production capabilities, alternative product availabilities, or market demand. The information included herein is believed to be accurate and reliable. However, Allegro MicroSystems assumes no responsibility for its use; nor for any infringements of patents or other rights of third parties which may result from its use.





FEATURES AND BENEFITS

- Integrated capacitor reduces requirements for external EMI protection components
- · Fully optimized differential digital gear tooth sensor IC
- · Running mode lockout
- · AGC and reference adjust circuit
- Air gap independent switchpoints
- · Digital output representing target mechanical profile
- Precise duty cycle throughout operating temperature range
- Short power-on time
- · Large operating air gap capability
- True zero-speed operation
- Undervoltage lockout (UVLO)
- Wide operating voltage range
- · Internal current regulator for two-wire operation
- Robust test coverage capability with Scan Path and IDDQ measurements
- Single-chip sensing IC for high reliability
- Integrated rare-earth pellet

PACKAGE: 3-pin SIP (suffix SN)



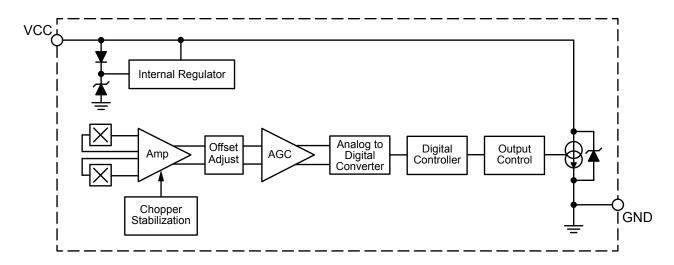
DESCRIPTION

The ATS688LSN is an optimized Hall-effect integrated circuit (IC), rare-earth pellet, and high-temperature ceramic capacitor in a single overmolded package, reducing the need for external EMC protection. The ATS688LSN provides a user-friendly solution for true zero-speed digital gear tooth sensing in two-wire applications.

The single integrated circuit incorporates a dual element Hall-effect sensor IC and signal processing circuitry that switches in response to differential magnetic signals created by a rotating ferromagnetic target. The device contains a sophisticated compensating circuit to eliminate magnetic and system offsets. Digital tracking of the analog signal is used to achieve true zero-speed operation. Advanced calibration algorithms are used to adjust the device gain and offset at power-up, resulting in air gap independent switchpoints, which greatly improves output accuracy and mitigates the effect of system anomalies such as target vibration and sudden changes in air gap.

The regulated current output is configured for two-wire operation. This sensor IC is ideal for obtaining edge and duty cycle information in gear-tooth-based applications such as wheel speed.

The ATS688LSN is provided in a lead (Pb) free 3-pin backbiased SIP package (suffix SN) with tin leadframe plating. The ATS688LSN provides a user-friendly solution for true zero-speed digital gear tooth sensing in two-wire applications, such as automotive or two-wheeler braking systems.



Functional Block Diagram

SELECTION GUIDE

Part Number	Power-On State	Packing*
ATS688LSNTN-L-T	I _{CC(LOW)}	13-in. reel, 800 pieces per reel
ATS688LSNTN-H-T	I _{CC(HIGH)}	13-in. reel, 800 pieces per reel



SPECIFICATIONS

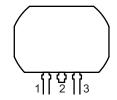
ABSOLUTE MAXIMUM RATINGS

Characteristic	Symbol	Notes	Rating	Units
Supply Voltage	V _{CC}		28	V
Reverse Supply Voltage	V _{RCC}		-18	V
Operating Ambient Temperature	T _A	Range L, refer to Power Derating Curve	-40 to 150	°C
Maximum Junction Temperature	T _J (max)		165	°C
Storage Temperature	T _{stg}		-65 to 170	°C

INTERNAL DISCRETE CAPACITOR RATINGS

Characteristic	Symbol	Notes	Rating	Units
Nominal Capacitance	C _{SUPPLY}	Connected between VCC and GND	10000	pF

PINOUT DIAGRAM AND TERMINAL LIST



Package SN, 3-Pin SIP Pinout Diagram

Terminal List Table

Number	Name	Function
1	VCC	Supply voltage
2	VCC	Supply voltage
3	GND	Ground



^{*}Contact Allegro $^{\text{\tiny{TM}}}$ for additional packing options

ATS688LSN

Two-Wire, Zero-Speed Differential Gear Tooth Sensor IC

OPERATING CHARACTERISTICS: V_{CC} and T_A within specification, unless otherwise noted

Characteristics	Symbol	Test Conditions	Min.	Typ.[1]	Max.	Unit ^[2]
ELECTRICAL CHARACTERISTI	cs					
Supply Voltage [3]	V _{CC}	Operating, T _J < T _J (max)	4.0	_	24	V
Undervoltage Lockout	V _{CC(UV)}	$V_{CC} 0 \rightarrow 5 \text{ V or } 5 \rightarrow 0 \text{ V}$	_	3.5	3.95	V
Reverse Supply Current ^[4]	I _{RCC}	V _{CC} = V _{RCC (MAX)}	_	_	-10	mA
Supply Zener Clamp Voltage	V _{ZSUPPLY}	I _{CC} = I _{CC (HIGH)} + 3 mA, T _A = 25°C	28	_	_	V
Supply Zener Current	I _{ZSUPPLY}	T _A = 25°C, V _{CC} = 28 V	_	_	19	mA
Supply Current	I _{CC(LOW)}	Low-current state	5.9	_	8.4	mA
Supply Current	I _{CC(HIGH)}	High-current state	12	_	16	mA
Supply Current Ratio	I _{CC(HIGH)} /I _{CC(LOW)}	Ratio of high current to low current	1.85	_	-	_
POWER-ON STATE CHARACTE	RISTICS					
Power-On State ^[5]	POS	-H variant	_	I _{CC(HIGH)}	_	mA
Power-On State 19	P05	-L variant	_	I _{CC(LOW)}	_	mA
OUTPUT STAGE						
Output Rise Time ^[6]	t _r	Corresponds to measured output slew rate, from 10% to 90% I $_{\rm CC}$ level C $_{\rm SUPPLY}$, R $_{\rm SENSE}$ = 100 Ω	0	2	4	μs
Output Fall Time ^[6]	t _r	Corresponds to measured output slew rate, from 90% to 10% I $_{\rm CC}$ level C $_{\rm SUPPLY}$, R $_{\rm SENSE}$ = 100 Ω	0	2	4	μs
PERFORMANCE CHARACTERIS	STICS					
Operating Frequency	f _{OP}		0	_	5	kHz
Operate Point	B _{OP}	% of peak-to-peak B _{SIG} , AG _{OP} within		60	-	%
Release Point	B _{RP}	% of peak-to-peak B _{SIG} , AG _{OP} within specification	-	40	-	%

Continued on the next page...



OPERATING CHARACTERISTICS (continued): V_{CC} and T_A within specification, unless otherwise noted

Characteristics	Symbol	Test Conditions	Min.	Typ. [1]	Max.	Unit ^[2]
FUNCTIONAL CHARACTERISTICS						
Operational Air Gap Range	AG _{OP}	Using Allegro Reference Target 60-0, duty cycle within specification		-	2.5	mm
Extended Operational Air Gap Range	AG _{EXT}	Using Allegro Reference Target 60-0, output switching (no missed edges), duty cycle not guaranteed	-	-	3.0	mm
Allowable User-Induced Differential Offset	B _{DIFFEXT}	Operation within specification	±60	_	_	G
Duty Cycle Variation	ΔD	Wobble < 0.5 mm, AG within specification	_	_	±10	%
Maximum Sudden Signal Amplitude Change	B _{SEQ(n+1)} / B _{SEQ(n)}	No missed output edge. Instantaneous symmetric magnetic signal amplitude change, measured as a percentage of peak-to-peak B _{SIG} (see Figure 1).	-	0.6	-	-
Maximum Total Signal Amplitude Change	B _{SEQ(max)} /B _{SEQ(min)}	Overall symmetric magnetic signal amplitude change, measured as a percentage of peak-to-peak B _{SIG} .	_	0.2	-	-
Front-End Chopping Frequency	f _C		_	400	_	kHz

^[1] Typical values are at $T_A = 25$ °C and $V_{CC} = 12$ V. Performance may vary for individual units, within the specified maximum and minimum limits.

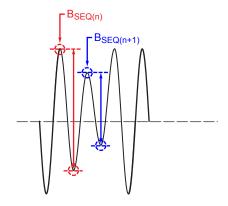


Figure 1: Differential Signal Variation

^[2] 1 G (gauss) = 0.1 mT (millitesla).

^[3] Maximum voltage must be adjusted for power dissipation and junction temperature; see Power Derating section.

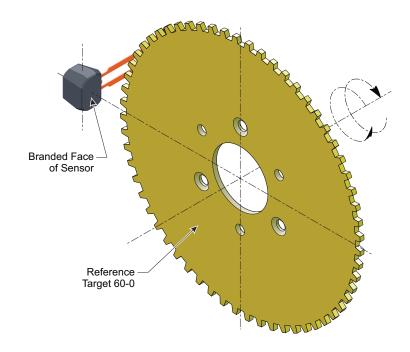
^[4] Negative current is defined as conventional current coming out of (sourced from) the specified device terminal.

^[5] Refer to the Functional Description, Power-On section.

^[6] Guaranteed by device characterization.

Reference Target 60-0 (60 Tooth Target)

Characteristics	Symbol	Test Conditions	Тур.	Units	Symbol Key
Outside Diameter	D _o	Outside diameter of target	120	mm	$^{\varnothing}D_{o}$ $^{\uparrow}$ $^{\uparrow}$ $^{\downarrow}$
Face Width	F	Breadth of tooth, with respect to branded face	6	mm	
Circular Tooth Length	t	Length of tooth, with respect to branded face	3	deg.	Branded Face of Package
Circular Valley Width	t _v	Length of valley, with respect to branded face	3	deg.	
Tooth Whole Depth	h _t		3	mm	
Material		Low Carbon Steel	_	_	Air Gap



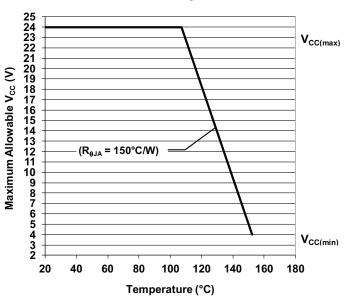


THERMAL CHARACTERISTICS: May require derating at maximum conditions; see Power Derating section

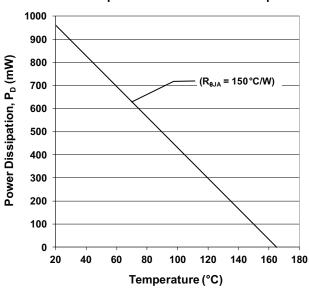
Characteristic	Symbol	Test Conditions*	Value	Unit
Package Thermal Resistance	$R_{ heta JA}$	Single layer PCB, with copper limited to solder pads	150	°C/W

^{*}Additional thermal information available on the Allegro website

Power Derating Curve



Power Dissipation versus Ambient Temperature





FUNCTIONAL DESCRIPTION

Sensing Technology

The ATS688 sensor IC contains a single-chip differential Hall-effect circuit, a back-biasing pellet, and a flat ferrous pole piece (a precisely-mounted magnetic field concentrator that homogenizes the flux passing through the Hall chip). As shown in Figure 2, the circuit supports two Hall elements, which sense the magnetic profile of the ferromagnetic gear target simultaneously,

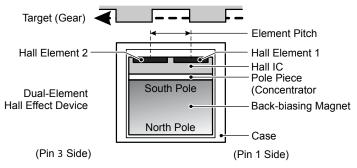


Figure 2: Relative Motion of the Target is Detected by the Dual Hall Elements Mounted on the Hall IC.

Mechanical Position (Target moves past pin 1 to pin 3)

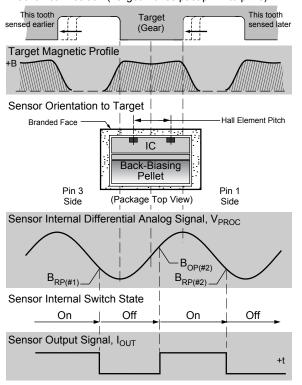


Figure 3: The Magnetic Profile Reflects the Geometry of the Target, Allowing the ATS688 to Present an Accurate Digital Output Response (-H variant shown).

but at different points (spaced at a 1.75 mm pitch), generating a differential internal analog voltage, V_{PROC} , that is processed for precise switching of the digital output signal.

The Hall IC is self-calibrating and also integrates a temperature compensated amplifier and offset cancellation circuitry. Its voltage regulator provides supply noise rejection throughout the operating voltage range. Changes in temperature do not greatly affect this device due to the stable amplifier design and the offset rejection circuitry. The Hall transducers and signal processing electronics are integrated on the same silicon substrate, using a proprietary BiCMOS process.

Target Profiling During Operation

Under normal operating conditions, the IC is capable of providing digital information that is representative of the mechanical features of a rotating gear. The waveform diagram in Figure 3 presents the automatic translation of the mechanical profile, through the magnetic profile that it induces, to the digital output signal of the ATS688. No additional optimization is needed and minimal processing circuitry is required. This ease of use reduces design time and incremental assembly costs for most applications.

Diagnostics

The regulated current output is configured for two-wire applications, requiring one less wire for operation than do switches with the traditional open-collector output. Additionally, the system designer inherently gains diagnostics because there is always output current flowing, which should be in either of two narrow ranges, shown in Figure 4 as $I_{\rm CC(HIGH)}$ and $I_{\rm CC(LOW)}$. Any current level not within these ranges indicates a fault condition. If $I_{\rm CC} > I_{\rm CC(HIGH)}({\rm max})$, then a short condition exists, and if $I_{\rm CC} < I_{\rm CC(LOW)}({\rm min})$, then an open condition exists. Any value of $I_{\rm CC}$ between the allowed ranges for $I_{\rm CC(HIGH)}$ and $I_{\rm CC(LOW)}$ indicates a general fault condition.

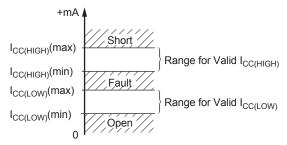


Figure 4: Diagnostic Characteristics of Supply Current Values.



Determining Output Signal Polarity

In Figure 3, the top panel, labeled *Mechanical Position*, represents the mechanical features of the target gear and orientation to the device. The bottom panel, labeled *Device Output Signal*, displays the square waveform corresponding to the digital output signal (current amplitude) that results from a rotating gear configured as shown in Figure 5. Referring to the target side nearest the face of the sensor IC, the direction of rotation is: perpendicular to the leads, across the face of the device, from the pin 1 side to the pin 3 side.

With the -H variant, this results in the IC output switching from $I_{CC(HIGH)}$ to $I_{CC(LOW)}$ as the leading edge of a tooth (a rising mechanical edge, as detected by the IC) passes the package face. The output polarity is inverted for the -L variant.

If the direction of rotation is reversed, so that the gear rotates from the pin 3 side to the pin 1 side, then the output polarity inverts from that of the pin 1 to 3 rotation.

To read the output signal as a voltage (V_{SENSE}), a sense resistor (R_{SENSE}) can be placed on either the VCC signal or on the GND signal. As shown in Figure 5, when R_{SENSE} is placed on the GND signal, the output signal voltage ($V_{SENSE(LowSide)}$) is in phase with I_{CC} . When R_{SENSE} is placed on the VCC signal, the output signal voltage ($V_{SENSE(HighSide)}$) is inverted relative to I_{CC} .

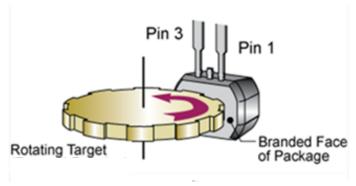
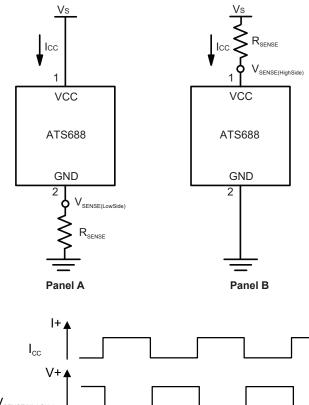


Figure 5: Left-to-Right, Pin 1 to Pin 3
Direction of Target Rotation.



V_{SENSE(HighSide)}
V_{SENSE(LowSide)}

Figure 6: Alternative Polarity Configurations Using Two-Wire Sensing.

Panel C

The Output Polarity States table provides the permutations of output voltage relative to $I_{CC},$ given alternative locations for $R_{SENSE}.$ Panel A shows the low-side ($V_{SENSE(LowSide)})$ sensing configuration, and panel B shows the high-side ($V_{SENSE(HighSide)})$ configuration. As shown in panel C, $V_{SENSE(LowSide)}$ is in phase with $I_{CC},$ and $V_{SENSE(HighSide)},$ is inverted.

POWER DERATING

The device must be operated below the maximum junction temperature of the device $(T_{J(max)})$. Under certain combinations of peak conditions, reliable operation may require derating supplied power or improving the heat dissipation properties of the application. This section presents a procedure for correlating factors affecting operating T_J . (Thermal data is also available on the Allegro website.)

The Package Thermal Resistance ($R_{\theta JA}$) is a figure of merit summarizing the ability of the application and the device to dissipate heat from the junction (die), through all paths to the ambient air. Its primary component is the Effective Thermal Conductivity (K) of the printed circuit board, including adjacent devices and traces. Radiation from the die through the device case ($R_{\theta JC}$) is relatively small component of $R_{\theta JA}$. Ambient air temperature (T_A) and air motion are significant external factors, damped by overmolding.

The effect of varying power levels (Power Dissipation, P_D), can be estimated. The following formulas represent the fundamental relationships used to estimate T_J , at P_D .

$$P_D = V_{IN} \times I_{IN} \tag{1}$$

$$\Delta T = P_D \times R_{\Theta IA} \tag{2}$$

$$T_{J} = T_{A} + \Delta T \tag{3}$$

For example, given common conditions such as: T_A = 25°C, V_{CC} = 12 V, I_{CC} = 6 mA, and $R_{\theta JA}$ = 150°C/W, then:

$$P_D = V_{CC} \times I_{CC} = 12 V \times 6 \text{ mA} = 72 \text{ mW}$$

$$\Delta T = P_D \times R_{\theta JA} = 72 \text{ mW} \times 150^{\circ}\text{C/W} = 10.8^{\circ}\text{C}$$

 $T_I = T_A + \Delta T = 25^{\circ}\text{C} + 10.8^{\circ}\text{C} = 35.8^{\circ}\text{C}$

A worst-case estimate, $P_D(max)$, represents the maximum allowable power level ($V_{CC}(max)$, $I_{CC}(max)$), without exceeding $T_J(max)$, at a selected $R_{\theta JA}$ and T_A

Example: Reliability for V_{CC} at T_A =150°C, package SN, using a single-layer PCB.

Observe the worst-case ratings for the device, specifically: $R_{\theta JA} = 150^{\circ}\text{C/W}$, $T_{J}(\text{max}) = 165^{\circ}\text{C}$, and $I_{CC}(\text{max}) = 16 \text{ mA}$.

Calculate the maximum allowable power level, $P_D(max)$. First, invert equation 3:

$$\Delta T_{max} = T_{J}(max) - T_{A} = 165 \,^{\circ}C - 150 \,^{\circ}C = 15 \,^{\circ}C$$

This provides the allowable increase to T_J resulting from internal power dissipation. Then, invert equation 2:

$$P_D(max) = \Delta T_{max} \div R_{0.14} = 15^{\circ}C \div 150^{\circ}C/W = 100 \text{ mW}$$

Finally, invert equation 1 with respect to voltage:

$$V_{CC}(est) = P_D(max) \div I_{CC}(max) = 100 \text{ mW} \div 16 \text{ mA} = 6.3 \text{ V}$$

The result indicates that, at T_A , the application and device can dissipate adequate amounts of heat at voltages $\leq V_{CC}(est)$.

Compare $V_{CC}(est)$ to $V_{CC}(max)$. If $V_{CC}(est) \leq V_{CC}(max)$, then reliable operation between $V_{CC}(est)$ and $V_{CC}(max)$ requires enhanced $R_{\theta JA}$. If $V_{CC}(est) \geq V_{CC}(max)$, then operation between $V_{CC}(est)$ and $V_{CC}(max)$ is reliable under these conditions.



PACKAGE OUTLINE DRAWING

For Reference Only – Not for Tooling Use (Reference DWG-9206, Rev.2)

(Reference DWG-9206, Rev.2)
Dimensions in millimeters – NOT TO SCALE
Dimensions exclusive of mold flash, gate burs, and dambar protrusions
Exact case and lead configuration at supplier discretion within limits shown

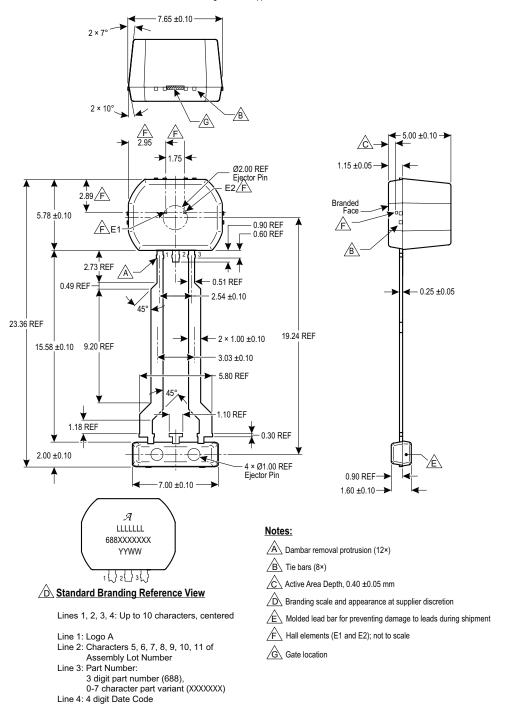


Figure 7: Package SN, 3-Pin SIP



ATS688LSN

Two-Wire, Zero-Speed Differential Gear Tooth Sensor IC

Revision History

Number	Date	Description
-	October 19, 2017	Initial release
1	April 9, 2021	Product status changed to discontinued.

Copyright 2021, Allegro MicroSystems.

Allegro MicroSystems reserves the right to make, from time to time, such departures from the detail specifications as may be required to permit improvements in the performance, reliability, or manufacturability of its products. Before placing an order, the user is cautioned to verify that the information being relied upon is current.

Allegro's products are not to be used in any devices or systems, including but not limited to life support devices or systems, in which a failure of Allegro's product can reasonably be expected to cause bodily harm.

The information included herein is believed to be accurate and reliable. However, Allegro MicroSystems assumes no responsibility for its use; nor for any infringement of patents or other rights of third parties which may result from its use.

Copies of this document are considered uncontrolled documents.

For the latest version of this document, visit our website:

www.allegromicro.com

